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(AN/"Kateeva" AND AC/"Newark"): 113 patents.
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	PAT. NO.	Title
1	11,261,339	Multiamine ligands for nanoparticle solubilization and ink compositions containing nanoparticles capped with the ligands
2	11,260,679	Gripping for print substrates
3	11,255,018	Methods for producing an etch resist pattern on a metallic surface
4	11,251,411	Systems and methods for supporting and conveying a substrate
5	11,234,334	Guided transport path correction
6	11,233,226	Nozzle-droplet combination techniques to deposit fluids in substrate locations within precise tolerances
7	11,230,757	Method and apparatus for load-locked printing
8	11,225,097	Inkjet printer with temperature controlled substrate support
9	11,203,207	Techniques for manufacturing thin films with improved homogeneity and print speed
10	11,181,779	Quantum dot color filter ink compositions and devices utilizing the same
11	11,167,303	Techniques for arrayed printing of a permanent layer with improved speed and accuracy
12	11,155,728	Quantum dot material and method of curing
13	11,155,077	Printer calibration module
14	11,141,752	Techniques for arrayed printing of a permanent layer with improved speed and accuracy
15	11,135,854	Ejection control using imager
16	11,135,835	Ejection control using substrate alignment features and print region alignment features
17	11,123,983	Inkjet printer with substrate flatness detection
18	11,107,991	Analysis of material layers on surfaces, and related systems and methods
19	11,097,560	Inkjet printer with substrate height position control
20	11,088,035	Fabrication of thin-film encapsulation layer for light emitting device
21	11,043,653	Light-emitting devices with improved light outcoupling
22	11,034,176	Gas enclosure assembly and system
23	11,006,528	Methods of etching conductive features, and related devices and systems
24	11,004,835	Light-emitting diodes with light coupling and conversion layers
25	10,985,217	High resolution organic light-emitting diode devices, displays, and related methods

26 10,950,826 T Techniques for print ink droplet measurement and control to deposit fluids within precise tolerances
27 10,900,678 T Gas enclosure assembly and system
28 10,886,504 T Systems, devices and methods for the quality assessment of OLED stack films
29 10,875,329 T Printing system assemblies and methods
30 10,851,450 T Method and apparatus for load-locked printing
31 10,847,756 T Inkjet printing systems and techniques for light-emitting devices with enhanced light outcoupling
32 10,811,324 T Fabrication of thin-film encapsulation layer for light emitting device
33 10,806,035 T Methods for producing an etch resist pattern on a metallic surface
34 10,804,417 T Display devices utilizing quantum dots and inkjet printing techniques thereof
35 10,797,270 T Nozzle-droplet combination techniques to deposit fluids in substrate locations within precise tolerances
36 10,786,995 T Ink delivery systems and methods
37 10,784,472 T Nozzle-droplet combination techniques to deposit fluids in substrate locations within precise tolerances
38 10,784,470 T Techniques for print ink droplet measurement and control to deposit fluids within precise tolerances
39 10,743,420 T Methods for producing an etch resist pattern on a metallic surface
40 10,707,273 T High resolution organic light-emitting diode devices, displays, and related methods
41 10,662,343 T Ester-based solvent systems for printable organic light-emitting diode ink formulations
42 10,654,299 T Low-particle gas enclosure systems and methods
43 10,608,182 T Analysis of material layers on surfaces, and related systems and methods
44 10,586,742 T Fabrication of thin-film encapsulation layer for light emitting device
45 10,580,841 T High resolution organic light-emitting diode devices, displays, and related method
46 10,537,911 T Gas cushion apparatus and techniques for substrate coating
47 10,533,104 T Two-step process for forming cured polymeric films for electronic device encapsulation
48 10,522,601 T High resolution organic light-emitting diode devices, displays, and related method
49 10,522,425 T Fabrication of thin-film encapsulation layer for light emitting device
50 10,519,535 T Method and apparatus for load-locked printing

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